

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hiroshi Fukui

Confirmation No.: 7869

Serial No.: 10/533,849

Filed: October 24, 2005

Group Art Unit: 1796

Examiner: Matochik, T. L.

For: HEAT CONDUCTIVE SILICONE COMPOSITION

SECOND RESPONSE AFTER FINAL

Mailstop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the Final Office Action dated February 29, 2008, and as a Supplemental to the Request For Reconsideration filed on April 10, 2008, please consider the accompanying remarks. A complete listing of all claims pending in the application is included for the Examiner's convenience. This response is timely filed; thus, it is believed that no fees are presently due. Further, this response is filed within two months of the mailing date of the Final Office Action.